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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	80MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	85
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 28x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	124-VFTLA Dual Rows, Exposed Pad
Supplier Device Package	124-VTLA (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx470f512l-i-tl

PIC32MX330/350/370/430/450/470

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Referenced Sources

This device data sheet is based on the following individual sections of the “PIC32 Family Reference Manual”. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note: To access the following documents, refer to the *Documentation > Reference Manuals* section of the Microchip PIC32 website: <http://www.microchip.com/pic32>.

- **Section 1. “Introduction”** (DS60001127)
- **Section 2. “CPU”** (DS60001113)
- **Section 3. “Memory Organization”** (DS60001115)
- **Section 4. “Prefetch Cache”** (DS60001119)
- **Section 5. “Flash Program Memory”** (DS60001121)
- **Section 6. “Oscillator Configuration”** (DS60001112)
- **Section 7. “Resets”** (DS60001118)
- **Section 8. “Interrupt Controller”** (DS60001108)
- **Section 9. “Watchdog Timer and Power-up Timer”** (DS60001114)
- **Section 10. “Power-Saving Features”** (DS60001130)
- **Section 12. “I/O Ports”** (DS60001120)
- **Section 13. “Parallel Master Port (PMP)”** (DS60001128)
- **Section 14. “Timers”** (DS60001105)
- **Section 15. “Input Capture”** (DS60001122)
- **Section 16. “Output Compare”** (DS60001111)
- **Section 17. “10-bit Analog-to-Digital Converter (ADC)”** (DS60001104)
- **Section 19. “Comparator”** (DS60001110)
- **Section 20. “Comparator Voltage Reference (CVREF)”** (DS60001109)
- **Section 21. “Universal Asynchronous Receiver Transmitter (UART)”** (DS60001107)
- **Section 23. “Serial Peripheral Interface (SPI)”** (DS60001106)
- **Section 24. “Inter-Integrated Circuit (I²C)”** (DS60001116)
- **Section 27. “USB On-The-Go (OTG)”** (DS60001126)
- **Section 29. “Real-Time Clock and Calendar (RTCC)”** (DS60001125)
- **Section 31. “Direct Memory Access (DMA) Controller”** (DS60001117)
- **Section 32. “Configuration”** (DS60001124)
- **Section 33. “Programming and Diagnostics”** (DS60001129)
- **Section 37. “Charge Time Measurement Unit (CTMU)”** (DS60001167)

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TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number			Pin Type	Buffer Type	Description
	64-pin QFN/TQFP	100-pin TQFP	124-pin VTLA			
CTED4	22	33	B19	I	ST	CTMU External Edge Input 4
CTED5	29	43	B24	I	ST	CTMU External Edge Input 5
CTED6	30	44	A29	I	ST	CTMU External Edge Input 6
CTED7	—	9	B5	I	ST	CTMU External Edge Input 7
CTED8	—	92	A62	I	ST	CTMU External Edge Input 8
CTED9	—	60	A40	I	ST	CTMU External Edge Input 9
CTED10	21	32	A23	I	ST	CTMU External Edge Input 10
CTED11	23	34	A24	I	ST	CTMU External Edge Input 11
CTED12	15	24	A15	I	ST	CTMU External Edge Input 12
CTED13	14	23	B13	I	ST	CTMU External Edge Input 13
MCLR	7	13	B7	I/P	ST	Master Clear (Reset) input. This pin is an active-low Reset to the device.
AVDD	19	30	A22	P	P	Positive supply for analog modules. This pin must be connected at all times.
AVSS	20	31	B18	P	P	Ground reference for analog modules
VDD	10, 26, 38, 57	2, 16, 37, 46, 62, 86	B1, A10, A14, B21, A30, A41, A48, A59, B53	P	—	Positive supply for peripheral logic and I/O pins
VCAP	56	85	B48	P	—	Capacitor for Internal Voltage Regulator
VSS	9, 25, 41	15, 36, 45, 65, 75	A3, B8, B12, A25, B25, A43, B41, A63	P	—	Ground reference for logic and I/O pins
VREF+	16	29	B17	I	Analog	Analog Voltage Reference (High) Input
VREF-	15	28	A21	I	Analog	Analog Voltage Reference (Low) Input

Legend: CMOS = CMOS compatible input or output Analog = Analog input P = Power
 ST = Schmitt Trigger input with CMOS levels O = Output I = Input
 TTL = TTL input buffer

- Note 1:** This pin is only available on devices without a USB module.
Note 2: This pin is only available on devices with a USB module.
Note 3: This pin is not available on 64-pin devices.

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REGISTER 4-4: BMXDUPBA: DATA RAM USER PROGRAM BASE ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0
	BMXDUPBA<15:8>							
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	BMXDUPBA<7:0>							

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-10 **BMXDUPBA<15:10>**: DRM User Program Base Address bits

When non-zero, the value selects the relative base address for User mode program space in RAM, BMXDUPBA must be greater than BMXDUDBA.

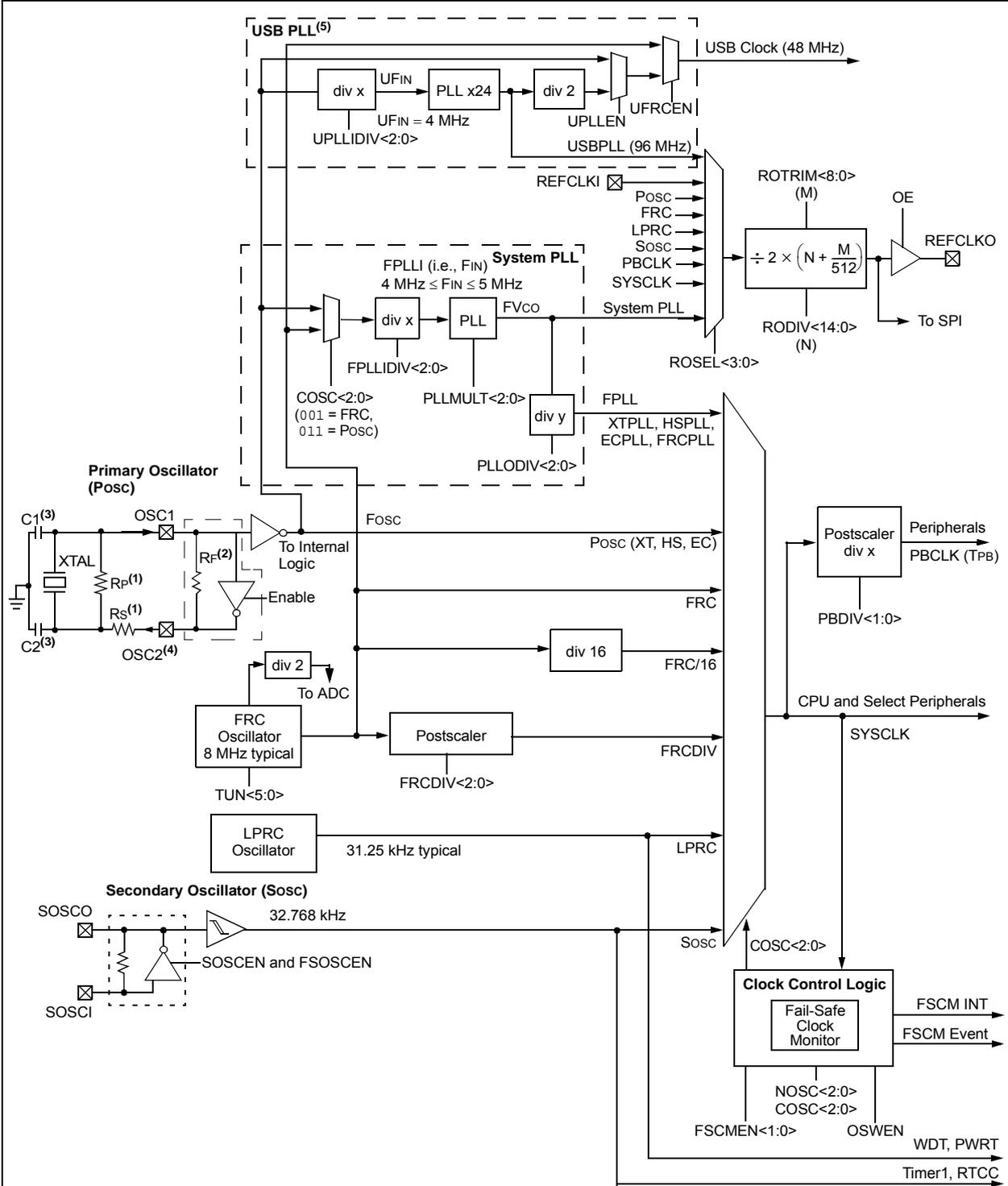
bit 9-0 **BMXDUPBA<9:0>**: Read-Only bits

Value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernel mode data usage.
2: The value in this register must be less than or equal to BMXDRMSZ.

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FIGURE 8-1: PIC32MX330/350/370/430/450/470 FAMILY CLOCK DIAGRAM



- Notes:**
1. A series resistor, R_s , may be required for AT strip cut crystals or eliminate clipping. Alternately, to increase oscillator circuit gain, add a parallel resistor, R_p , with a value of 1 M Ω .
 2. The internal feedback resistor, R_f , is typically in the range of 2 M Ω to 10 M Ω .
 3. Refer to Section 6, "Oscillator Configuration" (DS60001112) in the "PIC32 Family Reference Manual" for help in determining the best oscillator components.
 4. PBCLK out is available on the OSC2 pin in certain clock modes.
 5. USB PLL is available on PIC32MX4XX devices only.

8.1 Oscillator Control Registers

TABLE 8-1: OSCILLATOR CONTROL REGISTER MAP

Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	Bits															All Resets	
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1		16/0
F000	OSCCON	31:16	—	—	PLLODIV<2:0>			FRCDIV<2:0>			—	SOSCRDY	PBDIVRDY	PBDIV<1:0>		PLLMULT<2:0>			x1xx ⁽²⁾
		15:0	—	COSC<2:0>			—	NOSC<2:0>			CLKLOCK	ULOCK ⁽⁴⁾	SLOCK	SLPEN	CF	UFRGEN ⁽⁴⁾	SOSCEN	OSWEN	xxxx ⁽²⁾
F010	OSCTUN	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	TUN<5:0>					0000	
F020	REFOCON	31:16	—	RODIV<14:0>														0000	
		15:0	ON	—	SIDL	OE	RSLP	—	DIVSWEN	ACTIVE	—	—	—	—	—	ROSEL<3:0>			0000
F030	REFOTRIM	31:16	ROTRIM<8:0>														0000		
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

- Note**
- 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 12.2 "CLR, SET, and INV Registers" for more information.
 - 2: Reset values are dependent on the DEVCFGx Configuration bits and the type of reset.
 - 3: This bit is only available on devices with a USB module.

10.1 Control Registers

TABLE 10-1: DMA GLOBAL REGISTER MAP

Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
3000	DMACON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	ON	—	—	SUSPEND	DMABUSY	—	—	—	—	—	—	—	—	—	—	0000	
3010	DMASTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	RDWR	DMACH<2:0>		0000	
3020	DMAADDR	31:16	DMAADDR<31:0>																0000
		15:0	DMAADDR<31:0>																0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.2 “CLR, SET, and INV Registers”** for more information.

TABLE 10-2: DMA CRC REGISTER MAP

Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
3030	DCRCCON	31:16	—	—	BYTO<1:0>		WBO	—	—	BITO	—	—	—	—	—	—	—	0000	
		15:0	—	—	—	PLEN<4:0>				CRCEN	CRCAPP	CRCTYP	—	—	CRCCH<2:0>			0000	
3040	DCRCDATA	31:16	DCRCDATA<31:0>																0000
		15:0	DCRCDATA<31:0>																0000
3050	DCRCXOR	31:16	DCRCXOR<31:0>																0000
		15:0	DCRCXOR<31:0>																0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.2 “CLR, SET, and INV Registers”** for more information.

TABLE 10-3: DMA CHANNEL 0 THROUGH CHANNEL 3 REGISTER MAP (CONTINUED)

Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	Bits															All Resets	
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1		16/0
3280	DCH2CPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHCPTR<15:0>															0000	
3290	DCH2DAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHPDAT<7:0>															0000	
32A0	DCH3CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHBUSY	—	—	—	—	—	—	CHCHNS	CHEN	CHAED	CHCHN	CHAEN	—	CHEDET	—	CHPRI<1:0>	0000
32B0	DCH3ECON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	00FF
		15:0	CHSIRQ<7:0>							CFORCE	CABORT	PATEN	SIRQEN	AIRQEN	—	—	—	FFF8	
32C0	DCH3INT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	CHSDIF	CHSHIF	CHDDIF	CHDHIF	CHBCIF	CHCCIF	CHTAIF	CHERIF	0000
32D0	DCH3SSA	31:16	CHSSA<31:0>															0000	
		15:0																0000	
32E0	DCH3DSA	31:16	CHDSA<31:0>															0000	
		15:0																0000	
32F0	DCH3SSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHSSIZ<15:0>															0000	
3300	DCH3DSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHDSIZ<15:0>															0000	
3310	DCH3SPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHSPTR<15:0>															0000	
3320	DCH3DPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHDPTR<15:0>															0000	
3330	DCH3CSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHCSIZ<15:0>															0000	
3340	DCH3CPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHCPTR<15:0>															0000	
3350	DCH3DAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHPDAT<7:0>															0000	

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 12.2 "CLR, SET, and INV Registers" for more information.

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REGISTER 11-8: U1EIR: USB ERROR INTERRUPT STATUS REGISTER (CONTINUED)

bit 1 **CRC5EF:** CRC5 Host Error Flag bit⁽⁴⁾
1 = Token packet is rejected due to CRC5 error
0 = Token packet is accepted

EOFEF: EOF Error Flag bit^(3,5)
1 = EOF error condition is detected
0 = No EOF error condition

bit 0 **PIDEF:** PID Check Failure Flag bit
1 = PID check is failed
0 = PID check is passed

- Note 1:** This type of error occurs when the module's request for the DMA bus is not granted in time to service the module's demand for memory, resulting in an overflow or underflow condition, and/or the allocated buffer size is not sufficient to store the received data packet causing it to be truncated.
- 2:** This type of error occurs when more than 16-bit-times of Idle from the previous End-of-Packet (EOP) has elapsed.
- 3:** This type of error occurs when the module is transmitting or receiving data and the SOF counter has reached zero.
- 4:** Device mode.
- 5:** Host mode.

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REGISTER 11-11: U1CON: USB CONTROL REGISTER (CONTINUED)

- bit 1 **PPBRST:** Ping-Pong Buffers Reset bit
 1 = Reset all Even/Odd buffer pointers to the EVEN BD banks
 0 = Even/Odd buffer pointers not being Reset
- bit 0 **USBEN:** USB Module Enable bit⁽⁴⁾
 1 = USB module and supporting circuitry is enabled
 0 = USB module and supporting circuitry is disabled
- SOFEN:** SOF Enable bit⁽⁵⁾
 1 = SOF token sent every 1 ms
 0 = SOF token is disabled

- Note 1:** Software is required to check this bit before issuing another token command to the U1TOK register (see Register 11-15).
- 2:** All host control logic is reset any time that the value of this bit is toggled.
- 3:** Software must set the RESUME bit for 10 ms if the part is a function, or for 25 ms if the part is a host, and then clear it to enable remote wake-up. In Host mode, the USB module will append a low-speed EOP to the RESUME signaling when this bit is cleared.
- 4:** Device mode.
- 5:** Host mode.

TABLE 12-5: PORTC REGISTER MAP FOR PIC32MX330F064L, PIC32MX350F128L, PIC32MX350F256L, PIC32MX370F512L, PIC32MX430F064L, PIC32MX450F128L, PIC32MX450F256L, AND PIC32MX470F512L DEVICES ONLY

Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	Bits															All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	
6210	TRISC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	TRISC15	TRISC14	TRISC13	TRISC12	—	—	—	—	—	—	—	TRISC4	TRISC3	TRISC2	TRISC1	—
6220	PORTC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	RC15	RC14	RC13	RC12	—	—	—	—	—	—	—	RC4	RC3	RC2	RC1	—
6230	LATC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	LATC15	LATC14	LATC13	LATC12	—	—	—	—	—	—	—	LATC4	LATC3	LATC2	LATC1	—
6240	ODCC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ODCC15	ODCC14	ODCC13	ODCC12	—	—	—	—	—	—	—	ODCC4	ODCC3	ODCC2	ODCC1	—
6250	CNPUC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNPUC15	CNPUC14	CNPUC13	CNPUC12	—	—	—	—	—	—	—	CNPUC4	CNPUC3	CNPUC2	CNPUC1	—
6260	CNPDC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNPDC15	CNPDC14	CNPDC13	CNPDC12	—	—	—	—	—	—	—	CNPDC4	CNPDC3	CNPDC2	CNPDC1	—
6270	CNCONC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	—	—	—	—	—	—
6280	CNENC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNIEC15	CNIEC14	CNIEC13	CNIEC12	—	—	—	—	—	—	—	CNIEC4	CNIEC3	CNIEC2	CNIEC1	—
6290	CNSTATC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CNSTATC15	CNSTATC14	CNSTATC13	CNSTATC12	—	—	—	—	—	—	—	CNSTATC4	CNSTATC3	CNSTATC2	CNSTATC1	—

Legend: x = Unknown value on Reset; — = Unimplemented, read as '0'; Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.2 “CLR, SET, and INV Registers”** for more information.

13.2 Control Registers

TABLE 13-1: TIMER1 REGISTER MAP

Virtual Address (BF80_#)	Register Name(1)	Bit Range	Bits															All Resets	
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1		16/0
0600	T1CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	TWDIS	TWIP	—	—	—	TGATE	—	TCKPS<1:0>	—	TSYNC	TCS	—	—	0000
0610	TMR1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	TMR1<15:0>															0000	
0620	PR1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	PR1<15:0>															FFFF	

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 12.2 “CLR, SET, and INV Registers” for more information.

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REGISTER 18-1: SPIxCON: SPI CONTROL REGISTER (CONTINUED)

- bit 17 **SPIFE**: Frame Sync Pulse Edge Select bit (Framed SPI mode only)
1 = Frame synchronization pulse coincides with the first bit clock
0 = Frame synchronization pulse precedes the first bit clock
- bit 16 **ENHBUF**: Enhanced Buffer Enable bit⁽²⁾
1 = Enhanced Buffer mode is enabled
0 = Enhanced Buffer mode is disabled
- bit 15 **ON**: SPI Peripheral On bit⁽¹⁾
1 = SPI Peripheral is enabled
0 = SPI Peripheral is disabled
- bit 14 **Unimplemented**: Read as '0'
- bit 13 **SIDL**: Stop in Idle Mode bit
1 = Discontinue operation when CPU enters in Idle mode
0 = Continue operation in Idle mode
- bit 12 **DISSDO**: Disable SDOx pin bit
1 = SDOx pin is not used by the module. Pin is controlled by associated PORT register
0 = SDOx pin is controlled by the module
- bit 11-10 **MODE<32,16>**: 32/16-Bit Communication Select bits
When AUDEN = 1:
- | MODE32 | MODE16 | Communication |
|--------|--------|---|
| 1 | 1 | 24-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame |
| 1 | 0 | 32-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame |
| 0 | 1 | 16-bit Data, 16-bit FIFO, 32-bit Channel/64-bit Frame |
| 0 | 0 | 16-bit Data, 16-bit FIFO, 16-bit Channel/32-bit Frame |
- When AUDEN = 0:
- | MODE32 | MODE16 | Communication |
|--------|--------|---------------|
| 1 | x | 32-bit |
| 0 | 1 | 16-bit |
| 0 | 0 | 8-bit |
- bit 9 **SMP**: SPI Data Input Sample Phase bit
Master mode (MSTEN = 1):
1 = Input data sampled at end of data output time
0 = Input data sampled at middle of data output time
Slave mode (MSTEN = 0):
SMP value is ignored when SPI is used in Slave mode. The module always uses SMP = 0.
- bit 8 **CKE**: SPI Clock Edge Select bit⁽³⁾
1 = Serial output data changes on transition from active clock state to Idle clock state (see CKP bit)
0 = Serial output data changes on transition from Idle clock state to active clock state (see CKP bit)
- bit 7 **SSEN**: Slave Select Enable (Slave mode) bit
1 = \overline{SSx} pin used for Slave mode
0 = \overline{SSx} pin not used for Slave mode, pin controlled by port function.
- bit 6 **CKP**: Clock Polarity Select bit⁽⁴⁾
1 = Idle state for clock is a high level; active state is a low level
0 = Idle state for clock is a low level; active state is a high level
- bit 5 **MSTEN**: Master Mode Enable bit
1 = Master mode
0 = Slave mode

Note 1: When using the 1:1 PBCLK divisor, the user software should not read or write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

2: This bit can only be written when the ON bit = 0.

3: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).

4: When AUDEN = 1, the SPI module functions as if the CKP bit is equal to '1', regardless of the actual value of CKP.

21.1 Control Registers

TABLE 21-1: PARALLEL MASTER PORT REGISTER MAP

Virtual Address (BF80..#)	Register Name ⁽¹⁾	Bit Range	Bits															All Resets	
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1		16/0
7000	PMCON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	ADMUX<1:0>	PMP TTL	PTWREN	PTRDEN	CSF<1:0>	ALP	CS2P	CS1P	—	WRSP	RDSP	0000		
7010	PMMODE	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	BUSY	IRQM<1:0>	INCM<1:0>	MODE16	MODE<1:0>	WAITB<1:0>	WAITM<3:0>	WAITE<1:0>	0000								
7020	PMADDR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	CS2	CS1	ADDR<13:0>													0000	
7030	PMDOUT	31:16	DATAOUT<31:0>															0000	
		15:0	DATAOUT<31:0>															0000	
7040	PMDIN	31:16	DATAIN<31:0>															0000	
		15:0	DATAIN<31:0>															0000	
7050	PMAEN	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	PTEN<15:0>															0000	
7060	PMSTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	IBF	IBOV	—	—	IB3F	IB2F	IB1F	IB0F	OBE	OBUF	—	—	OB3E	OB2E	OB1E	OB0E	BFBF

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 12.2 "CLR, SET, and INV Registers" for more information.

24.1 Control Registers

TABLE 24-1: COMPARATOR REGISTER MAP

Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	Bits															All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	
A000	CM1CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	COE	CPOL	—	—	—	—	COUT	EVPOL<1:0>	—	CREF	—	—	CCH<1:0>		E1C3
A010	CM2CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	COE	CPOL	—	—	—	—	COUT	EVPOL<1:0>	—	CREF	—	—	CCH<1:0>		E1C3
A060	CMSTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	SIDL	—	—	—	—	—	—	—	—	—	—	—	C2OUT	C1OUT

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 12.2 "CLR, SET, and INV Registers" for more information.

REGISTER 26-1: CTMUCON: CTMU CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	EDG1MOD	EDG1POL	EDG1SEL<3:0>				EDG2STAT	EDG1STAT
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
	EDG2MOD	EDG2POL	EDG2SEL<3:0>				—	—
15:8	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ON	—	CTMUSIDL	TGEN ⁽¹⁾	EDGEN	EDGSEQEN	IDISSEN ⁽²⁾	CTTRIG
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ITRIM<5:0>						IRNG<1:0>	

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31 **EDG1MOD:** Edge 1 Edge Sampling Select bit

1 = Input is edge-sensitive
0 = Input is level-sensitive

bit 30 **EDG1POL:** Edge 1 Polarity Select bit

1 = Edge 1 programmed for a positive edge response
0 = Edge 1 programmed for a negative edge response

bit 29-26 **EDG1SEL<3:0>:** Edge 1 Source Select bits

1111 = Reserved
1110 = C2OUT pin is selected
1101 = C1OUT pin is selected
1100 = IC3 Capture Event is selected
1011 = IC2 Capture Event is selected
1010 = IC1 Capture Event is selected
1001 = CTED8 pin is selected
1000 = CTED7 pin is selected
0111 = CTED6 pin is selected
0110 = CTED5 pin is selected
0101 = CTED4 pin is selected
0100 = CTED3 pin is selected
0011 = CTED1 pin is selected
0010 = CTED2 pin is selected
0001 = OC1 Compare Event is selected
0000 = Timer1 Event is selected

bit 25 **EDG2STAT:** Edge 2 Status bit

Indicates the status of Edge 2 and can be written to control edge source

1 = Edge 2 has occurred
0 = Edge 2 has not occurred

Note 1: When this bit is set for Pulse Delay Generation, the EDG2SEL<3:0> bits must be set to '1110' to select C2OUT.

2: The ADC module Sample and Hold capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitive measurement, must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to '1', performs this function. The ADC module must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.

3: Refer to the CTMU Current Source Specifications (Table 31-42) in **Section 31.0 "Electrical Characteristics"** for current values.

4: This bit setting is not available for the CTMU temperature diode.

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TABLE 31-5: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature 0°C ≤ TA ≤ +70°C for Commercial -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +105°C for V-temp		
Parameter No.	Typical ⁽³⁾	Maximum	Units	Conditions	
Operating Current (IDD)^(1,2)					
DC20	2.5	4	mA	4 MHz	
DC21	6	9	mA	10 MHz (Note 4)	
DC22	11	17	mA	20 MHz (Note 4)	
DC23	21	32	mA	40 MHz (Note 4)	
DC24	30	45	mA	60 MHz (Note 4)	
DC25	40	60	mA	80 MHz	
DC25a	50	75	mA	100 MHz, -40°C ≤ TA ≤ +85°C	
DC25c	72	84	mA	120 MHz, 0°C ≤ TA ≤ +70°C	
DC26	100	—	μA	+25°C, 3.3V	LPRC (31 kHz) (Note 4)

Note 1: A device's IDD supply current is mainly a function of the operating voltage and frequency. Other factors, such as PBCLK (Peripheral Bus Clock) frequency, number of peripheral modules enabled, internal code execution pattern, execution from Program Flash memory vs. SRAM, I/O pin loading and switching rate, oscillator type, as well as temperature, can have an impact on the current consumption.

2: The test conditions for IDD measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU, program Flash, and SRAM data memory are operational, program Flash memory Wait states = 7, Program Cache and Prefetch are disabled and SRAM data memory Wait states = 1
- No peripheral modules are operating (ON bit = 0), but the associated PMD bit is clear
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to Vss
- $\overline{\text{MCLR}} = \text{VDD}$
- CPU executing `while(1)` statement from Flash
- RTCC and JTAG are disabled

3: Data in "Typical" column is at 3.3V, 25°C at specified operating frequency unless otherwise stated. Parameters are for design guidance only and are not tested.

4: This parameter is characterized, but not tested in manufacturing.

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TABLE 31-7: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD) (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature 0°C ≤ TA ≤ +70°C for Commercial -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +105°C for V-temp		
Param. No.	Typ. ⁽²⁾	Max.	Units	Conditions	
PIC32MX370 Devices Only					
Power-Down Current (IPD) (Note 1)					
DC40k	55	95	μA	-40°C	Base Power-Down Current
DC40l	81	95	μA	+25°C	
DC40n	281	450	μA	+85°C	
DC40m	559	895	μA	+105°C	
PIC32MX470 Devices Only					
Power-Down Current (IPD) (Note 1)					
DC40k	33	78	μA	-40°C	Base Power-Down Current
DC40o	33	78	μA	0°C ⁽⁵⁾	
DC40l	49	78	μA	+25°C	
DC40p	281	450	μA	+70°C ⁽⁵⁾	
DC40n	281	450	μA	+85°C	
DC40m	559	895	μA	+105°C	
PIC32MX330/350/370/430/450/470 Devices					
Module Differential Current					
DC41e	6.7	20	μA	3V	Watchdog Timer Current: ΔI _{WDT} (Note 3)
DC42e	29.1	50	μA	3V	RTCC + Timer1 w/32 kHz Crystal: ΔI _{RTCC} (Note 3)
DC43d	1000	1200	μA	3V	ADC: ΔI _{ADC} (Notes 3,4)

Note 1: The test conditions for IPD measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
 - OSC2/CLKO is configured as an I/O input pin
 - USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
 - CPU is in Sleep mode, program Flash memory Wait states = 7, Program Cache and Prefetch are disabled and SRAM data memory Wait states = 1
 - No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set
 - WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
 - All I/O pins are configured as inputs and pulled to V_{SS}
 - MCLR = V_{DD}
 - RTCC and JTAG are disabled
 - Voltage regulator is off during Sleep mode (VREGS bit in the RCON register = 0)
- 2:** Data in the “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 3:** The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4:** Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.
- 5:** 120 MHz commercial devices only (0°C to +70°C).

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Revision D (March 2015)

This revision includes the following updates, as listed in Table A-3.

TABLE A-3: MAJOR SECTION UPDATES

Section	Update Description
“32-bit Microcontrollers (up to 512 KB Flash and 128 KB SRAM) with Audio/Graphics/Touch (HMI), USB, and Advanced Analog”	100 MHz and 120 MHz operation information was added. Pins 59 through 63 of the 64-pin QFN and TQFP pin diagrams were updated.
2.0 “Guidelines for Getting Started with 32-bit MCUs”	Added 2.8.1 “Crystal Oscillator Design Consideration” .
12.0 “I/O Ports”	The Block Diagram of a Typical Multiplexed Port Structure was updated (see Figure 12-1).
21.0 “Parallel Master Port (PMP)”	The PMADDR: Parallel Port Address Register was updated (see Register 21-3).
31.0 “Electrical Characteristics”	Specifications for 120 MHz operation were added to the following tables: <ul style="list-style-type: none">• Table 31-1: “Operating MIPS vs. Voltage”• Table 31-5: “DC Characteristics: Operating Current (IDD)”• Table 31-6: “DC Characteristics: Idle Current (IDLE)”• Table 31-7: “DC Characteristics: Idle Current (IPD)”• Table 31-13: “DC Characteristics: Program Flash Memory Wait State”• Table 31-18: “External Clock Timing Requirements” The unit of measure for IDLE Current parameters DC37a, DC37b, and DC37c were updated (see Table 31-6). Parameter D312 (TSET) was removed from the Comparator Specifications (see Table 31-14). Comparator Voltage Reference Specifications were added (see Table 31-15). Parameter OS10 (FOSC) in the External Clock Timing Requirements was updated (see Table 31-18). Parameter USB321 (VOL) in the OTG Electrical Specifications was updated (see Table 31-41).
32.0 “Packaging Information”	The 64-lead QFN package marking information was updated. The 124-lead VTLA package land pattern information was added.
“Product Identification System”	The Speed category was removed. The Example was updated. The MR package was updated. The RG package was added.